

HAC T-Coil Signal Test Report

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Testing laboratory:	TCC Nokia Salo Laboratory P.O.Box 86 Joensuunkatu 7H / Kiila 1B FIN-24101 SALO, FINLAND Tel. +358 (0) 7180 08000 Fax. +358 (0) 7180 45220	Client:	Nokia Corporation 12278 Scripps Summit Drive SAN DIEGO CA. 92131 USA Tel. +1 858 831 5000 Fax. +1 858 831 6500
Responsible test engineer:	Janne Hirsimäki	Product contact person:	Victoria Abadilla
Measurements made by:	Janne Hirsimäki		
Tested devices:	RM-809 (Hearing aid mode active)		
FCC ID:	QMNRM-809	IC:	661X-RM809
Supplement reports:	RF_RM-809_02, HAC_Photo_RM-809_03		
Testing has been carried out in accordance with:	ANSI C63.19-2007 American National Standard for Methods of Measurement of Compatibility between Wireless Communications Devices and Hearing Aids		
Documentation:	The documentation of the testing performed on the tested devices is archived for 15 years at TCC Nokia.		
Test results:	The tested device complies with the requirements in respect of all parameters subject to the test. The test results and statements relate only to the items tested. The test report shall not be reproduced except in full, without written approval of the laboratory.		
Date and signatures:			
For the contents:			

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1. SUMMARY OF HAC T-COIL SIGNAL TEST REPORT

1.1 Test Details

Period of test	2011-10-05 to 2011-10-10
SN, HW, SW and DUT numbers of tested device	SN: 004402/13/651099/1, HW: 0111, SW: 1600.2200.7720.11340, DUT: 15946
Batteries used in testing	BP-3L, DUT: 15943, 15944
State of sample	Prototype unit
Notes	AWF = -5 for GSM, 0 for WCDMA

1.2 Summary of T-Coil Test Results

1.2.1 T-Coil Coupling Field Intensity

1.2.1.1 Axial Field Intensity (z)

Mode	Minimum limit [dB (A/m)]	Result [dB (A/m)]	Verdict
GSM850	-18	4.27	Pass
WCDMA850	-18	2.93	Pass
WCDMA1700/2100	-18	3.84	Pass
GSM1900	-18	3.28	Pass
WCDMA1900	-18	2.63	Pass

1.2.1.2 Longitudinal Field Intensity (x)

Mode	Minimum limit [dB (A/m)]	Result [dB (A/m)]	Verdict
GSM850	-18	-4.86	Pass
WCDMA850	-18	-5.27	Pass
WCDMA1700/2100	-18	-4.21	Pass
GSM1900	-18	-4.89	Pass
WCDMA1900	-18	-5.54	Pass

1.2.1.3 Transversal Field Intensity (y)

Mode	Minimum limit [dB (A/m)]	Result [dB (A/m)]	Verdict
GSM850	-18	-4.46	Pass
WCDMA850	-18	-5.11	Pass
WCDMA1700/2100	-18	-5.17	Pass
GSM1900	-18	-4.73	Pass
WCDMA1900	-18	-5.19	Pass

1.2.2 Frequency Response at Axial Measurement Point

Mode	Verdict
GSM850	Pass
WCDMA850	Pass
WCDMA1700/2100	Pass
GSM1900	Pass
WCDMA1900	Pass

1.2.3 Signal Quality

Mode	Minimum limit [dB]				Minimum result [dB]	Category assessment
	T1	T2	T3	T4		
GSM850	0	10	20	30	25.5	T3
WCDMA850	0	10	20	30	35.4	T4
WCDMA1700/2100	0	10	20	30	24.6	T3
GSM1900	0	10	20	30	25.9	T3
WCDMA1900	0	10	20	30	32.6	T4

1.2.4 Overall HAC rating of the tested device

Mode	RF emissions category at T-coil axial measurement point (E- and H-fields)*	Category assessment, T-Coil signal quality	Combined HAC category of the tested device
GSM850	M3	T3	M3/T3
WCDMA850	M4	T4	
WCDMA1700/2100	M4	T3	
GSM1900	M4	T3	
WCDMA1900	M4	T4	

*See separate HAC RF report

2. DESCRIPTION OF THE DEVICE UNDER TEST (DUT)

Air-interface	Band (MHz)	Type	C63.19/ tested	Simultaneous Transmissions Note: not to be tested	Concurrent single transmission	Reduced power 20.19 (c) (1)	Voice Over Digital Transport (Data)
GSM	850	VO	Yes	Yes BT, WLAN	Yes: WCDMA Rated	No	NA
	1900				GPRS/EDGE, BT, WLAN Not rated	No	NA
	GPRS/EDGE	DT	NA	Yes BT, WLAN	Yes: * see note	NA*	YES
WCDMA	850 1700/2100 1900	V/D	Yes	Yes BT, WLAN	Yes: GSM Rated	No	YES
BT	2450	DT	NA	Yes GSM, GPRS/EDGE, WCDMA	NA*	NA*	NO
WLAN	2450	DT	NA	Yes GSM, GPRS/EDGE, WCDMA	NA*	NA*	YES

VO Voice CMRS/PSTN Service Only

V/D Voice CMRS/PSTN and Data Service

DT Digital Transport

*HAC Rating was not based on concurrent voice and data modes, Non current mode was found to represent worst case rating for both M and T rating.

Outside of USA the transmitter of the device is capable of operating also in 900MHz, 1800MHz and 2100MHz bands, which are not part of this filing.

2.1 Picture Of The Device

See separate report HAC_Photo_RM-809_03.

3. TEST CONDITIONS

3.1 Temperature and Humidity

Ambient temperature (°C):	21.0 to 23.0
Ambient humidity (RH %):	40 to 60

3.2 Device Control and Parameters

The transmitter of the device was put into operation by using a call tester. Communications between the device and the call tester were established by air link. Speech coding was processed with EFR speech codec for GSM and with AMR 12.2 kbps for WCDMA.

The device output power was set to maximum power level for all tests; a fully charged battery was used for every test sequence.

T-Coil mode was switched on from the device user interface, volume setting was set to maximum and microphone was muted.

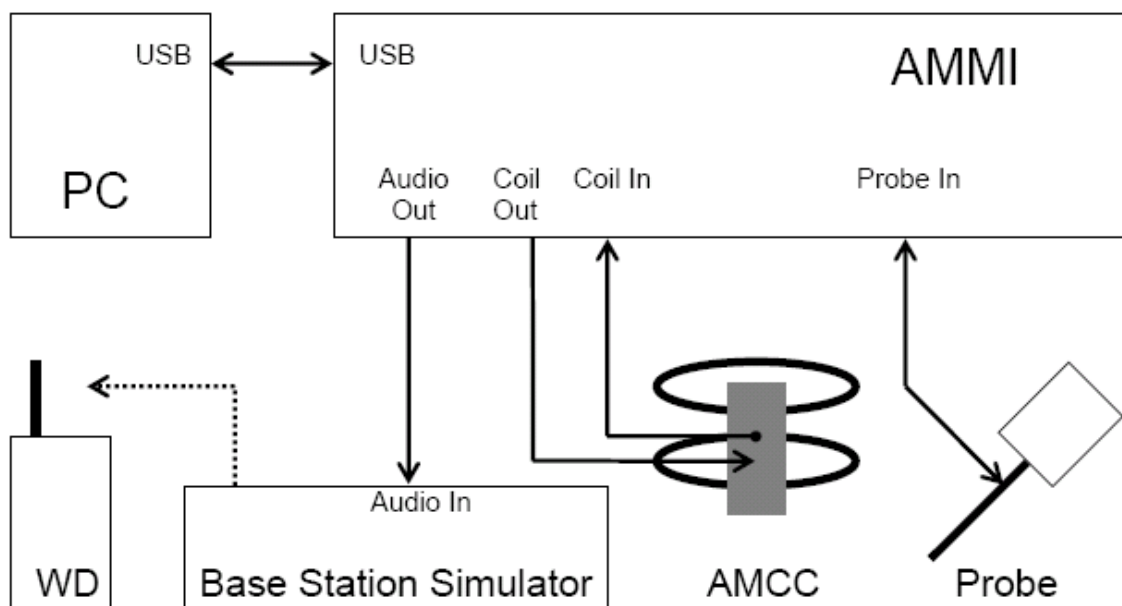
In all operating bands the measurements were performed on middle channel.

4. DESCRIPTION OF THE TEST EQUIPMENT

4.1 Measurement System and Components

The measurements were performed using an automated near-field scanning system, DASY52 version 52.6, manufactured by Schmid & Partner Engineering AG (SPEAG) in Switzerland.

Components and signal paths of used measurement system are pictured below:



The following table lists calibration dates of measurement equipment:

Test Equipment	Serial Number	Calibration interval	Calibration expiry
R&S CMU200 Radio Communication Test Set	101111	-	-
AM1DV3 Audio Magnetic Probe	3079	12 months	2011-11
AMMI Audio Magnetic Measurement Instrument	1002	-	-
AMCC Helmholtz Audio Magnetic Calibration Coil	1004	-	-

4.1.1 Audio Magnetic Probe AM1DV3

Construction	Fully RF shielded metal construction (RF sensitivity < -100dB)
System calibration	Calibrated using Helmholtz coil according to manufacturers instructions
Frequency range	0.1 – 20 kHz (HOX! test signal is limited to required BW of 300 to 3000 Hz, ANSI C63.19)
Sensitivity	< -50 dB A/m
Dimensions	Overall length: 290 mm; Tip diameter: 6 mm

4.1.2 Audio Magnetic Measurement Instrument AMMI

Sampling Rate	48 kHz / 24 bit
Dynamic Range	85 dB
Test Signal Generation	User selectable and predefined (via PC)
System calibration	Auto-calibration / full system calibration using AMCC with monitor output

4.1.3 Audio Magnetic Calibration Coil AMCC

Dimensions	370 x 370 x 196 mm (ANSI-C63.19 compliant)
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4.1.4 Device Holder

The device holder and Test Arch are manufactured by Speag (www.speag.com). Test arch is used for all tests i.e. for both validation testing and device testing. The holder and test arch conforms to the requirements of ANSI C63.19.

The SPEAG device holder (see Section 5.1) was used to position the test device in all tests.

4.2 Verification of the System

Audio Magnetic Probe AM1D is calibrated in AMCC Helmholtz Audio Magnetic Calibration Coil before each measurement procedure using calibration and reference signals.

R&S CMU200 audio codec and SPEAG AMMI audio paths (gain) were calibrated according to manufacturer's instructions.

5. DESCRIPTION OF THE TEST PROCEDURE

5.1 Test Arch and Device Holder

The test device was placed in the Device Holder (illustrated below) that is supplied by SPEAG. Using this positioner the tested device is positioned under Test Arch.



Device holder and Test Arch supplied by SPEAG

5.2 Test Positions

The device was positioned such that Device Reference Plane was touching the bottom of the Test Arch. The acoustic output is aligned with the intersection of the Test Arch's middle bar and dielectric wire. The WD is positioned always this way to ensure repeatability of the measurements. Coordinate system depicted below is used to define exact locations of measurement points relative to the center of the acoustic output.

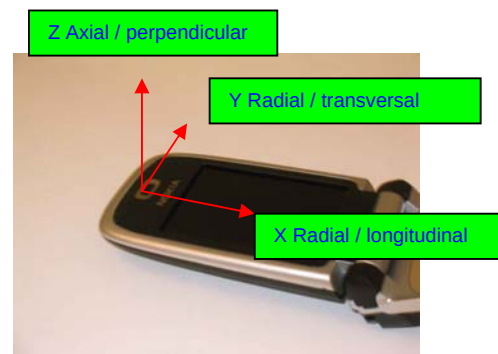


Photo of the device positioned under Test Arch and coordinate system (The EUT in picture is generic phone sample and does not represent the actual equipment under test)

5.3 T-Coil Scan Procedures and Used Test Signals

Manufacturer can either define measurement locations for WD categorization or optimum locations can be found using following procedure: First, large scans in all measurement orientations with dense grid step size are made to find locations of optimum signal. Point scans are made in these locations.

During measurements signal is fed to WD via communication tester. Proper gain setting is used in software to ensure correct signal level fed to communication tester speech input. Measurement software compares fed signal and signal from measurement probe and applies proper filtering and integration procedures.

Broadband voice-like signal (300...3000Hz) is used during scans and frequency response measurement to ensure proper operation of WD vocoder and audio enhancement algorithms.

In final measurement sine signal is used to determine signal strength @ 1025 Hz. Both signal (ABM1) and undesired audio noise (ABM2) are measured consequently to enable determination of signal to noise ratio (SNR).

5.4 T-Coil Requirements and Category Limits

RF Emissions

Wireless device has to fulfill RF emission requirements at the axial measurement location.

Axial, Longitudinal and Transversal Field Intensity

T-Coil signal magnetic field shall be $\geq -18\text{dB(A/m)}$ at 1 kHz, in 1/3 octave band filter for all orientations.

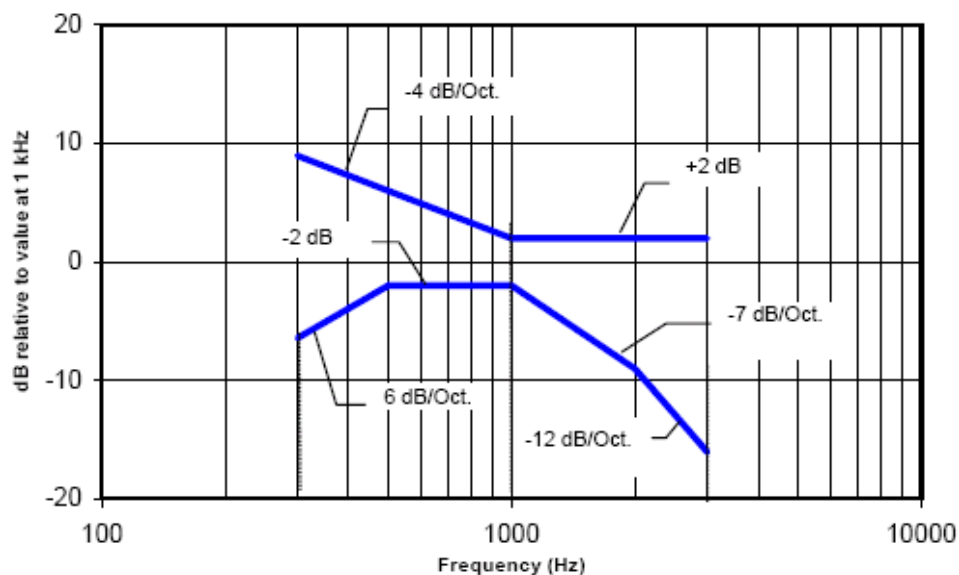
Signal Quality

The worst result of three T-Coil signal measurements is used to determine the T-Coil mode category:

Category	T1	T2	T3	T4
Limits for Signal Quality	0	10	20	30

Frequency Response

Frequency response of the axial component must be between the limits pointed by frequency curves below:



Magnetic field frequency response for devices with a field that exceeds -15dB (A/m) @ 1kHz.

6. MEASUREMENT UNCERTAINTY

Source of Uncertainty	Tolerance ±%	Probability Distribution	Div.	c ABM1	c ABM2	Standard Uncertainty ±%, ABM1	Standard Uncertainty ±%, ABM2
PROBE SENSITIVITY							
Reference level	3.0	N	1.0	1	1	3.0	3.0
AMCC geometry	0.4	R	√3	1	1	0.2	0.2
AMCC current	0.6	R	√3	1	1	0.4	0.4
Probe positioning during calibration	0.1	R	√3	1	1	0.1	0.1
Noise contribution	0.7	R	√3	0.0143	1	0.0	0.4
Frequency slope	5.9	R	√3	0.1	1.0	0.3	3.5
PROBE SYSTEM							
Repeatability / Drift	1.0	R	√3	1	1	0.6	0.6
Linearity / Dynamic range	0.6	R	√3	1	1	0.4	0.4
Acoustic noise	1.0	R	√3	0.1	1	0.1	0.6
Probe angle	2.3	R	√3	1	1	1.4	1.4
Spectral processing	0.9	R	√3	1	1	0.5	0.5
Integration time	0.6	N	1.0	1	5	0.6	3.0
Field disturbance	0.2	R	√3	1	1	0.1	0.1
TEST SIGNAL							
Reference signal spectral response	0.6	R	√3	0	1	0.0	0.4
POSITIONING							
Probe positioning	1.9	R	√3	1	1	1.1	1.1
Phantom thickness	0.9	R	√3	1	1	0.5	0.5
EUT Positioning	1.9	R	√3	1	1	1.1	1.1
EXTERNAL CONTRIBUTIONS							
RF interference	0.0	R	√3	1	1	0.0	0.0
Test signal variation	2.0	R	√3	1	1	1.2	1.2
COMBINED UNCERTAINTY							
Combined Standard Uncertainty (ABM field)						4.1	6.1
Expanded Standard Uncertainty [%]						8.1	12.3

7. RESULTS

Measurement location coordinates are defined as deviation from earpiece center in millimeters. Coordinate system is defined in chapter 4.2

GSM850 results

	Longitudinal (x)		Transversal (y)		Axial (z)			
					Max signal		Earpiece	
	x	y	x	y	x	y	x	y
Measurement location (x,y) [mm]	5.0	0.0	-1.5	-6.5	-1.5	0.0	0.0	0.0
Signal strength [dB A/m]	-4.86		-4.46		4.98		4.27	
ABM2 [dB A/m]	-32.96		-37.16		-31.02		-21.23	
Signal quality [dB]	28.1		32.7		36.0		25.5	
Ambient background noise at point (0,0) ABM [dB A/m]	-52.4		-53.7		-48.9		-48.9	

WCDMA850 results

	Longitudinal (x)		Transversal (y)		Axial (z)			
					Max signal		Earpiece	
	x	y	x	y	x	y	x	y
Measurement location (x,y) [mm]	5.0	-0.5	-1.5	-6.0	-1.5	0.0	0.0	0.0
Signal strength [dB A/m]	-5.27		-5.11		3.45		2.93	
ABM2 [dB A/m]	-45.87		-42.71		-33.65		-32.47	
Signal quality [dB]	40.6		37.6		37.1		35.4	
Ambient background noise at point (0,0) ABM [dB A/m]	-52.4		-53.7		-48.9		-48.9	

WCDMA 1700/2100 results

	Longitudinal (x)		Transversal (y)		Axial (z)			
					Max signal		Earpiece	
	x	y	x	y	x	y	x	y
Measurement location (x,y) [mm]	5.0	0.0	-1.5	-6.5	-1.5	0.0	0.0	0.0
Signal strength [dB A/m]	-4.21		-5.17		4.54		3.84	
ABM2 [dB A/m]	-40.21		-43.07		-23.96		-20.76	
Signal quality [dB]	36.0		37.9		28.5		24.6	
Ambient background noise at point (0,0) ABM [dB A/m]	-52.4		-53.7		-48.9		-48.9	

GSM1900 results

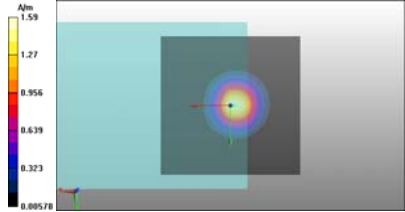
	Longitudinal (x)		Transversal (y)		Axial (z)			
					Max signal		Earpiece	
	x	y	x	y	x	y	x	y
Measurement location (x,y) [mm]	5.0	0.0	-1.5	-6.5	-1.5	0.0	0.0	0.0
Signal strength [dB A/m]	-4.89		-4.73		3.83		3.28	
ABM2 [dB A/m]	-36.59		-40.53		-32.07		-22.62	
Signal quality [dB]	31.7		35.8		35.9		25.9	
Ambient background noise at point (0,0) ABM [dB A/m]	-52.4		-53.7		-48.9		-48.9	

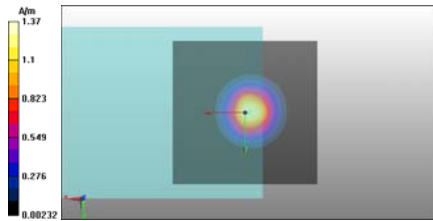
WCDMA1900 results

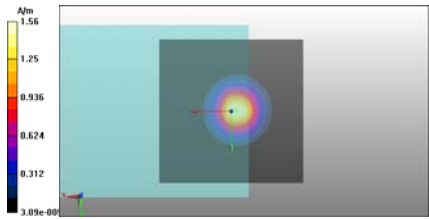
	Longitudinal (x)		Transversal (y)		Axial (z)			
					Max signal		Earpiece	
	x	y	x	y	x	y	x	y
Measurement location (x,y) [mm]	5.0	0.0	-1.5	-6.5	-1.5	0.0	0.0	0.0
Signal strength [dB A/m]	-5.54		-5.19		3.28		2.63	
ABM2 [dB A/m]	-47.24		-43.49		-33.52		-29.97	
Signal quality [dB]	41.7		38.3		36.8		32.6	
Ambient background noise at point (0,0) ABM [dB A/m]	-52.4		-53.7		-48.9		-48.9	

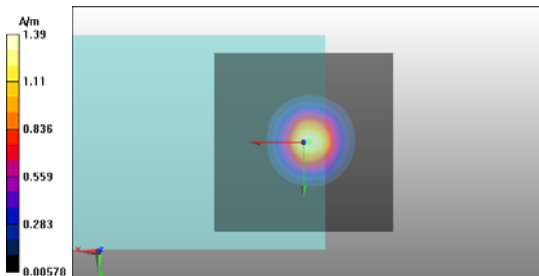
Plots of the measurement scans are presented in Appendix A.

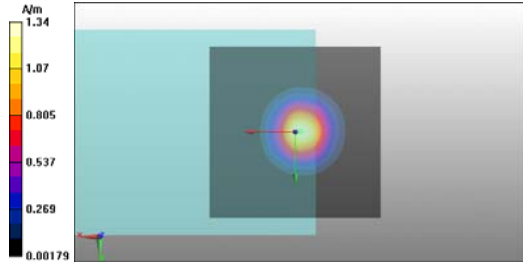
APPENDIX A: MEASUREMENT SCANS

Axial Measurements, GSM850	
Date/Time: 06.10.2011 10:51:36 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: Generic GSM Frequency: 836.6 MHz; Duty Cycle: 1:8.30042 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil GSM850 z/General Scans/z (axial) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = 4.04 dB A/m Location: -1.5, 0, 3.7 mm	
T-Coil GSM850 z/General Scans/point scan at best SNR(z)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.0111976 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 36 dB ABM1 comp = 4.98 dB A/m BWC Factor = 0.0111976 dB Location: -1.5, 0, 3.7 mm T-Coil GSM850 z/General Scans/point scan at ACOUSTIC OUTPUT location/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.0111976 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 25.5 dB ABM1 comp = 4.27 dB A/m BWC Factor = 0.0111976 dB Location: 0, 0, 3.7 mm	
	
T-Coil/Background Noise/z (axial) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -48.9 dB A/m Location: 0, 0, 13 mm	

Axial Measurements, WCDMA850	
Date/Time: 05.10.2011 12:52:52 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: WCDMA850 Frequency: 835 MHz; Duty Cycle: 1:1 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil WCDMA5/General Scans/z (axial) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = 2.73 dB A/m BWC Factor = 10.8 dB Location: -1.5, 0, 3.7 mm	
T-Coil WCDMA5/General Scans/point scan at best SNR(z)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.0102433 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 37.1 dB ABM1 comp = 3.45 dB A/m BWC Factor = 0.0102433 dB Location: -1.5, 0, 3.7 mm T-Coil WCDMA5/General Scans/point scan at ACOUSTIC OUTPUT location/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.0102433 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 35.4 dB ABM1 comp = 2.93 dB A/m BWC Factor = 0.0102433 dB Location: 0, 0, 3.7 mm	
	
T-Coil/Background Noise/z (axial) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -48.9 dB A/m Location: 0, 0, 13 mm	

Axial Measurements, WCDMA1700/2100	
Date/Time: 06.10.2011 11:32:26 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: WCDMA1700/2100 Frequency: 1732.4 MHz; Duty Cycle: 1:1 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil WCDMA4/General Scans/z (axial) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = 3.85 dB A/m BWC Factor = 10.8 dB Location: -1.5, 0, 3.7 mm	
T-Coil WCDMA4/General Scans/point scan at best SNR(z)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.00980951 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 28.5 dB ABM1 comp = 4.54 dB A/m BWC Factor = 0.00980951 dB Location: -1.5, 0, 3.7 mm T-Coil WCDMA4/General Scans/point scan at ACOUSTIC OUTPUT location/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.00980951 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 24.6 dB ABM1 comp = 3.84 dB A/m BWC Factor = 0.00980951 dB Location: 0, 0, 3.7 mm	
	
T-Coil/Background Noise/z (axial) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -48.9 dB A/m Location: 0, 0, 13 mm	

Axial Measurements, GSM1900	
Date/Time: 05.10.2011 11:38:26 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: Generic GSM Frequency: 1880 MHz; Duty Cycle: 1:8.30042 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil GSM1900/General Scans/z (axial) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = 2.88 dB A/m BWC Factor = 10.8 dB Location: -1.5, 0, 3.7 mm	
T-Coil GSM1900/General Scans/point scan at best SNR(z)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.0100698 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 35.9 dB ABM1 comp = 3.83 dB A/m BWC Factor = 0.0100698 dB Location: -1.5, 0, 3.7 mm	
T-Coil GSM1900/General Scans/point scan at ACOUSTIC OUTPUT location/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.0100698 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 25.9 dB ABM1 comp = 3.28 dB A/m BWC Factor = 0.0100698 dB Location: 0, 0, 3.7 mm	
	
T-Coil/Background Noise/z (axial) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -48.9 dB A/m Location: 0, 0, 13 mm	

Axial Measurements, WCDMA1900	
Date/Time: 05.10.2011 14:12:26 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: WCDMA1900 Frequency: 1880 MHz; Duty Cycle: 1:1 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil WCDMA2/General Scans/z (axial) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = 2.56 dB A/m BWC Factor = 10.8 dB Location: -1.5, 0, 3.7 mm	
T-Coil WCDMA2/General Scans/point scan at best SNR(z)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.00998303 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 36.8 dB ABM1 comp = 3.28 dB A/m BWC Factor = 0.00998303 dB Location: -1.5, 0, 3.7 mm T-Coil WCDMA2/General Scans/point scan at ACOUSTIC OUTPUT location/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.00998303 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 32.6 dB ABM1 comp = 2.63 dB A/m BWC Factor = 0.00998303 dB Location: 0, 0, 3.7 mm	
	
T-Coil/Background Noise/z (axial) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -48.9 dB A/m Location: 0, 0, 13 mm	

HAC T-Coil Report

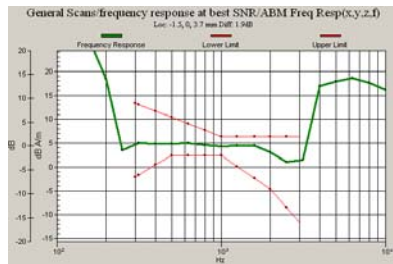
Type: RM-809

T-Coil_RM-809_01

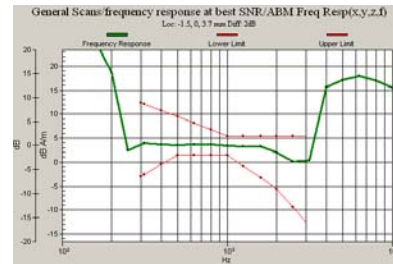
Applicant: Nokia Corporation

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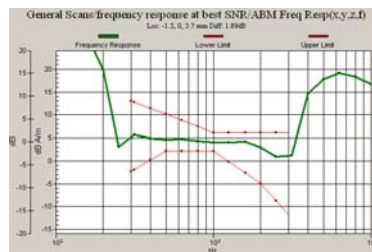
Frequency response in the point of maximum signal strength (axial)



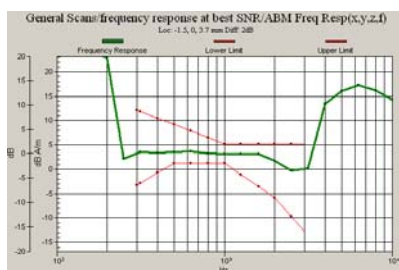
GSM850



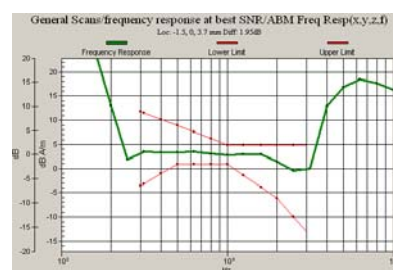
GSM1900



WCDMA1700/2100

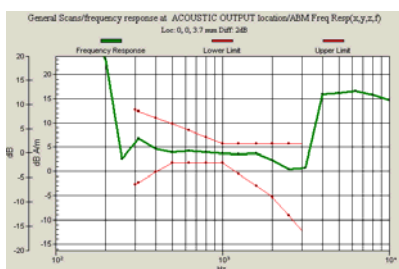


WCDMA850

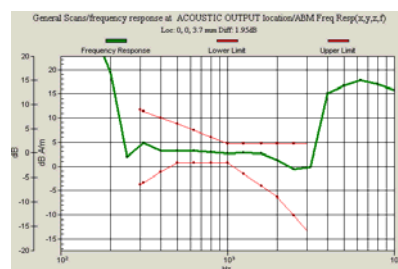


WCDMA1900

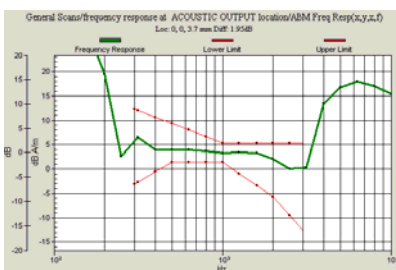
Frequency response over earpiece, point 0,0 (axial)



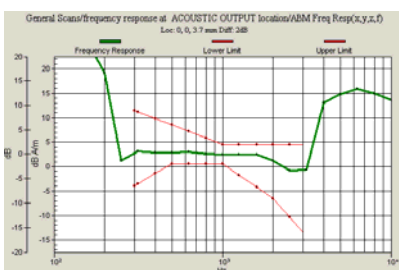
GSM850



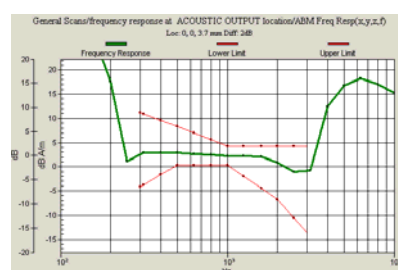
GSM1900



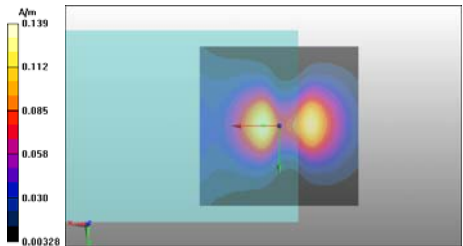
WCDMA1700/2100

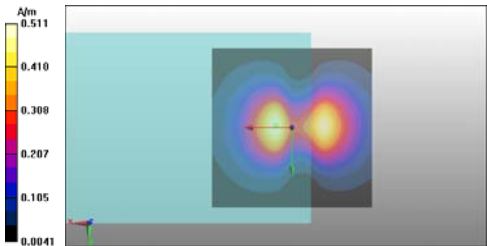


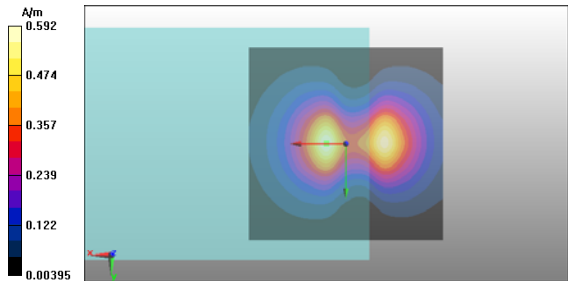
WCDMA850

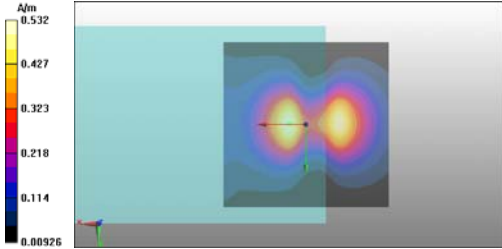


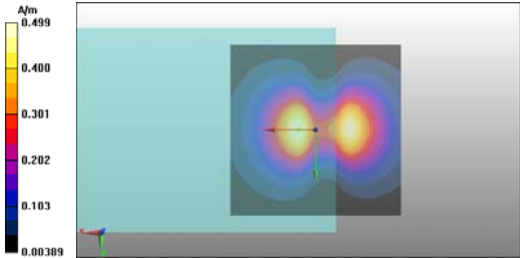
WCDMA1900

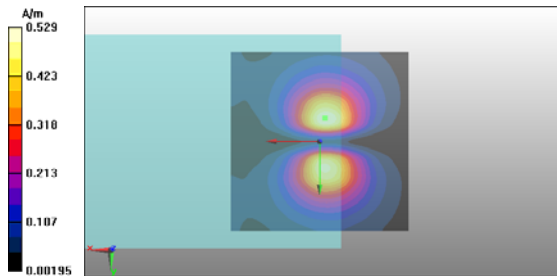
Longitudinal Measurements, GSM850	
Date/Time: 05.10.2011 10:43:13 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: Generic GSM Frequency: 836.6 MHz; Duty Cycle: 1:8.30042 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil GSM850/General Scans/x (longitudinal) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: -1.05 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = -17.2 dB A/m BWC Factor = -1.05 dB Location: 5, 0, 3.7 mm	
T-Coil GSM850/General Scans/point scan (x)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.0100698 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 28.1 dB ABM1 comp = -4.86 dB A/m BWC Factor = 0.0100698 dB Location: 5, 0, 3.7 mm	
	
T-Coil/Background Noise/x (longitudinal) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -52.4 dB A/m Location: 0, 0, 13 mm	

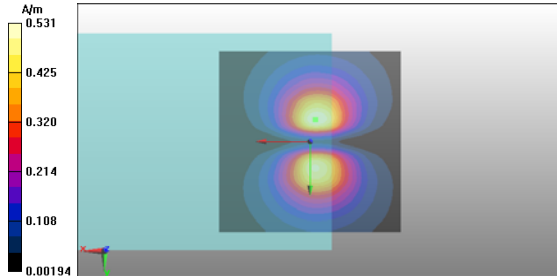
Longitudinal Measurements, WCDMA850	
Date/Time: 05.10.2011 13:14:22 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: WCDMA850 Frequency: 835 MHz; Duty Cycle: 1:1 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil WCDMA5/General Scans/x (longitudinal) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = -5.83 dB A/m BWC Factor = 10.8 dB Location: 5, -0.5, 3.7 mm	
T-Coil WCDMA5/General Scans/point scan (x)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.0102433 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 40.6 dB ABM1 comp = -5.27 dB A/m BWC Factor = 0.0102433 dB Location: 5, -0.5, 3.7 mm	
	
T-Coil/Background Noise/x (longitudinal) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -52.4 dB A/m Location: 0, 0, 13 mm	

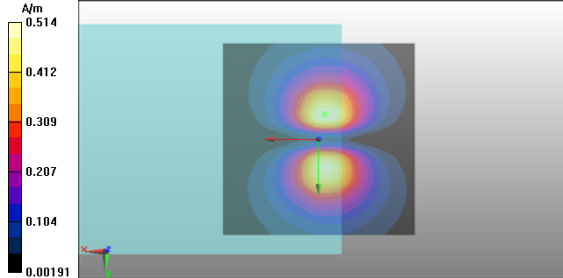
Longitudinal Measurements, WCDMA1700/2100	
Date/Time: 06.10.2011 11:53:57 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: WCDMA1700/2100 Frequency: 1732.4 MHz; Duty Cycle: 1:1 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil WCDMA4/General Scans/x (longitudinal) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = -4.56 dB A/m BWC Factor = 10.8 dB Location: 5, 0, 3.7 mm	
T-Coil WCDMA4/General Scans/point scan (x)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.00980951 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 36 dB ABM1 comp = -4.21 dB A/m BWC Factor = 0.00980951 dB Location: 5, 0, 3.7 mm	
	
T-Coil/Background Noise/x (longitudinal) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -52.4 dB A/m Location: 0, 0, 13 mm	

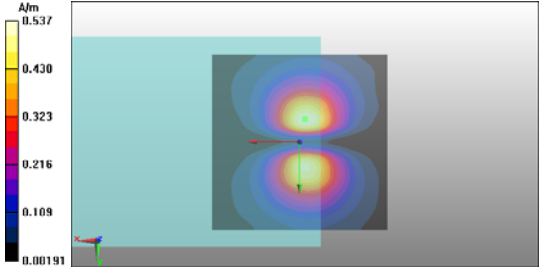
Longitudinal Measurements, GSM1900	
Date/Time: 05.10.2011 11:59:58 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: Generic GSM Frequency: 1880 MHz; Duty Cycle: 1:8.30042 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil GSM1900/General Scans/x (longitudinal) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = -5.47 dB A/m BWC Factor = 10.8 dB Location: 5, 0, 3.7 mm	
T-Coil GSM1900/General Scans/point scan (x)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.0100698 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 31.7 dB ABM1 comp = -4.89 dB A/m BWC Factor = 0.0100698 dB Location: 5, 0, 3.7 mm	
	
T-Coil/Background Noise/x (longitudinal) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -52.4 dB A/m Location: 0, 0, 13 mm	

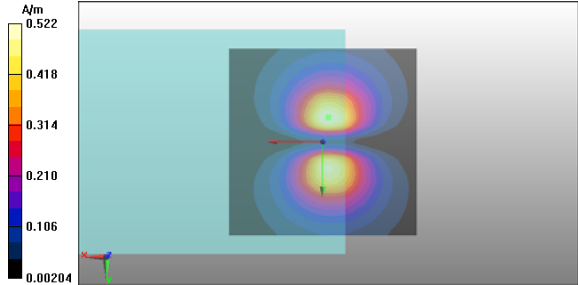
Longitudinal Measurements, WCDMA1900	
Date/Time: 05.10.2011 14:33:58 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: WCDMA1900 Frequency: 1880 MHz; Duty Cycle: 1:1 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil WCDMA2/General Scans/x (longitudinal) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = -6.03 dB A/m BWC Factor = 10.8 dB Location: 5, 0, 3.7 mm	
T-Coil WCDMA2/General Scans/point scan (x)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.00998303 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 41.7 dB ABM1 comp = -5.54 dB A/m BWC Factor = 0.00998303 dB Location: 5, 0, 3.7 mm	
	
T-Coil/Background Noise/x (longitudinal) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -52.4 dB A/m Location: 0, 0, 13 mm	

Transversal Measurements, GSM850	
Date/Time: 10.10.2011 08:29:05 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: Generic GSM Frequency: 836.6 MHz; Duty Cycle: 1:8.30042 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil GSM850/General Scans/y (transversal) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = -5.54 dB A/m BWC Factor = 10.8 dB Location: -1.5, -6.5, 3.7 mm	
T-Coil GSM850/General Scans/point scan (y)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.00902863 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 32.7 dB ABM1 comp = -4.46 dB A/m BWC Factor = 0.00902863 dB Location: -1.5, -6.5, 3.7 mm	
	
T-Coil/Background Noise/y (transversal) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -53.7 dB A/m Location: 0, 0, 13 mm	

Transversal Measurements, WCDMA850	
Date/Time: 10.10.2011 09:28:53 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: WCDMA850 Frequency: 835 MHz; Duty Cycle: 1:1 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil WCDMA5/General Scans/y (transversal) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = -5.49 dB A/m BWC Factor = 10.8 dB Location: -1.5, -6, 3.7 mm	
T-Coil WCDMA5/General Scans/point scan (y)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.0104168 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 37.6 dB ABM1 comp = -5.11 dB A/m BWC Factor = 0.0104168 dB Location: -1.5, -6, 3.7 mm	
	
T-Coil/Background Noise/y (transversal) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -53.7 dB A/m Location: 0, 0, 13 mm	

Transversal Measurements, WCDMA1700/2100	
Date/Time: 10.10.2011 10:27:06 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: WCDMA1700/2100 Frequency: 1732.4 MHz; Duty Cycle: 1:1 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil WCDMA4/General Scans/y (transversal) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = -5.77 dB A/m BWC Factor = 10.8 dB Location: -1.5, -6.5, 3.7 mm	
T-Coil WCDMA4/General Scans/point scan (y)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.0102433 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 37.9 dB ABM1 comp = -5.17 dB A/m BWC Factor = 0.0102433 dB Location: -1.5, -6.5, 3.7 mm	
	
T-Coil/Background Noise/y (transversal) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -53.7 dB A/m Location: 0, 0, 13 mm	

Transversal Measurements, GSM1900	
Date/Time: 10.10.2011 08:55:47 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: Generic GSM Frequency: 1880 MHz; Duty Cycle: 1:8.30042 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil GSM1900/General Scans/y (transversal) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = -5.4 dB A/m BWC Factor = 10.8 dB Location: -1.5, -6.5, 3.7 mm	
T-Coil GSM1900/General Scans/point scan (y)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.0104168 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 35.8 dB ABM1 comp = -4.73 dB A/m BWC Factor = 0.0104168 dB Location: -1.5, -6.5, 3.7 mm	
	
T-Coil/Background Noise/y (transversal) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -53.7 dB A/m Location: 0, 0, 13 mm	

Transversal Measurements, WCDMA1900	
Date/Time: 10.10.2011 09:59:07 Test Laboratory: TCC Nokia Type: RM-809; Serial: 004402/13/651099/1 Communication System: WCDMA1900 Frequency: 1880 MHz; Duty Cycle: 1:1 Medium: Air; Medium Notes: - Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³ Phantom section: TCoil Section	DASY Configuration: - Probe: AM1DV3 - 3079 - ; Calibrated: 29.11.2010 - Sensor-Surface: 0mm (Fix Surface) - Electronics: DAE4 Sn1213; Calibrated: 14.02.2011 - Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA; - Measurement SW: DASY52, V52.6 Build 2; SEMCAD X Version 14.0 Build 61
T-Coil WCDMA2/General Scans/y (transversal) coarse scan/ABM Interpolated Signal(x,y,z) (101x101x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav Output Gain: 72.7 BWC applied: 10.8 dB Device Reference Point: 0, 0, -6.3 mm ABM1 = -5.65 dB A/m BWC Factor = 10.8 dB Location: -1.5, -6.5, 3.7 mm	
T-Coil WCDMA2/General Scans/point scan (y)/ABM SNR(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Audio File (.wav) 48k_1.025kHz_10s.wav Output Gain: 8.52 BWC applied: 0.00902863 dB Device Reference Point: 0, 0, -6.3 mm ABM1/ABM2 = 38.3 dB ABM1 comp = -5.19 dB A/m BWC Factor = 0.00902863 dB Location: -1.5, -6.5, 3.7 mm	
	
T-Coil/Background Noise/y (transversal) noise/ABM Noise(x,y,z) (1x1x1): Measurement grid: dx=10mm, dy=10mm Signal Type: Off Output Gain: 0 Device Reference Point: 0, 0, -6.3 mm ABM2 = -53.7 dB A/m Location: 0, 0, 13 mm	

APPENDIX B: AUDIO MAGNETIC PROBE AM1DV3 CALIBRATION DOCUMENT



Accredited by the Swiss Accreditation Service (SAS)
 The Swiss Accreditation Service is one of the signatories to the EA
 Multilateral Agreement for the recognition of calibration certificates

Accreditation No.: **SCS 108**

Client **Nokia Salo PC Site**

Certificate No: **AM1DV3-3079_Nov10**

CALIBRATION CERTIFICATE

Object **AM1DV3 - SN: 3079**

Calibration procedure(s) **QA CAL-24.v2
 Calibration procedure for AM1D magnetic field probes and TMFS in the
 audio range**

Calibration date: **November 29, 2010**

This calibration certificate documents the traceability to national standards, which realize the physical units of measurements (SI).
 The measurements and the uncertainties with confidence probability are given on the following pages and are part of the certificate.

All calibrations have been conducted in the closed laboratory facility: environment temperature (22 ± 3)°C and humidity < 70%.

Calibration Equipment used (M&TE critical for calibration)

Primary Standards	ID #	Cal Date (Certificate No.)	Scheduled Calibration
Keithley Multimeter Type 2001	SN: 0810278	28-Sep-10 (No:10376)	Sep-11
Reference Probe AM1DV3	SN: 3000	6-Sep-10 (No. AM1D-3000_Sep10)	Sep-11
DAE4	SN: 781	22-Jan-10 (No. DAE4-781_Jan10)	Jan-11
Secondary Standards	ID #	Check Date (in house)	Scheduled Check
AMCC	1050	15-Oct-09 (in house check Oct-09)	Oct-11

	Name	Function	Signature
Calibrated by:	Mike Meili	Laboratory Technician	
Approved by:	Fin Bornholt	R&D Director	

Issued: November 29, 2010

This calibration certificate shall not be reproduced except in full without written approval of the laboratory.

References

- [1] ANSI C63.19-2007
American National Standard for Methods of Measurement of Compatibility between Wireless Communications Devices and Hearing Aids.
- [2] DASY4 manual, Chapter: Hearing Aid Compatibility (HAC) T-Coil Extension

Description of the AM1D probe

The AM1D Audio Magnetic Field Probe is a fully shielded magnetic field probe for the frequency range from 100 Hz to 20 kHz. The pickup coil is compliant with the dimensional requirements of [1]. The probe includes a symmetric low noise amplifier for the signal available at the shielded 3 pin connector at the side. Power is supplied via the same connector (phantom power supply) and monitored via the LED near the connector. The 7 pin connector at the end of the probe does not carry any signals, but determines the angle of the sensor when mounted on the DAE. The probe supports mechanical detection of the surface.

The single sensor in the probe is arranged in a tilt angle allowing measurement of 3 orthogonal field components when rotating the probe by 120° around its axis. It is aligned with the perpendicular component of the field, if the probe axis is tilted nominally 35.3° above the measurement plane, using the connector rotation and sensor angle stated below.

The probe is fully RF shielded when operated with the matching signal cable (shielded) and allows measurement of audio magnetic fields in the close vicinity of RF emitting wireless devices according to [1] without additional shielding.

Handling of the item

The probe is manufactured from stainless steel. In order to maintain the performance and calibration of the probe, it must not be opened. The probe is designed for operation in air and shall not be exposed to humidity or liquids. For proper operation of the surface detection and emergency stop functions in a DASY system, the probe must be operated with the special probe cup provided (larger diameter).

Methods Applied and Interpretation of Parameters

- *Coordinate System:* The AM1D probe is mounted in the DASY system for operation with a HAC Test Arch phantom with AMCC Helmholtz calibration coil according to [2], with the tip pointing to “southwest” orientation.
- *Functional Test:* The functional test preceding calibration includes test of Noise level
RF immunity (1kHz AM modulated signal). The shield of the probe cable must be well connected.
Frequency response verification from 100 Hz to 10 kHz.
- *Connector Rotation:* The connector at the end of the probe does not carry any signals and is used for fixation to the DAE only. The probe is operated in the center of the AMCC Helmholtz coil using a 1 kHz magnetic field signal. Its angle is determined from the two minima at nominally +120° and –120° rotation, so the sensor in the tip of the probe is aligned to the vertical plane in z-direction, corresponding to the field maximum in the AMCC Helmholtz calibration coil.
- *Sensor Angle:* The sensor tilting in the vertical plane from the ideal vertical direction is determined from the two minima at nominally +120° and –120°. DASY system uses this angle to align the sensor for radial measurements to the x and y axis in the horizontal plane.
- *Sensitivity:* With the probe sensor aligned to the z-field in the AMCC, the output of the probe is compared to the magnetic field in the AMCC at 1 kHz. The field in the AMCC Helmholtz coil is given by the geometry and the current through the coil, which is monitored on the precision shunt resistor of the coil.

AM1D probe identification and configuration data

Item	AM1DV3 Audio Magnetic 1D Field Probe
Type No	SP AM1 001 BA
Serial No	3079

Overall length	296 mm
Tip diameter	6.0 mm (at the tip)
Sensor offset	3.0 mm (centre of sensor from tip)
Internal Amplifier	20 dB

Manufacturer / Origin	Schmid & Partner Engineering AG, Zürich, Switzerland
Manufacturing date	Mar-2010
Last calibration date	n/a

Calibration data

Connector rotation angle	(in DASY system)	142.8 °	+/- 3.6 ° (k=2)
Sensor angle	(in DASY system)	0.60 °	+/- 0.5 ° (k=2)
Sensitivity at 1 kHz	(in DASY system)	0.00738 V / (A/m)	+/- 2.2 % (k=2)